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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

E·XFI

Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	I ² C, SPI
Peripherals	LCD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	7KB (4K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	176 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 6V
Data Converters	A/D 5x8b
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	64-TQFP
Supplier Device Package	64-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lc924t-04-pt

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5.4 PORTD and TRISD Registers

PORTD is an 8-bit port with Schmitt Trigger input buffers. The first five pins are configurable as general purpose I/O pins or LCD segment drivers. Pins RD5, RD6 and RD7 can be digital inputs or LCD segment or common drivers.

TRISD controls the direction of pins RD0 through RD4 when PORTD is configured as a digital port.

Note:	On a Power-on Reset these pins are con-
	figured as LCD segment drivers.

Note: To configure the pins as a digital port, the corresponding bits in the LCDSE register must be cleared. Any bit set in the LCDSE register overrides any bit settings in the corresponding TRIS register.

EXAMPLE 5-4: INITIALIZING PORTD

BCF	STATUS, RPO	;Select Bank2
BSF	STATUS, RP1	i
BCF	LCDSE,SE29	;Make RD<7:5> digital
BCF	LCDSE,SE0	;Make RD<4:0> digital
BSF	STATUS, RPO	;Select Bank1
BCF	STATUS, RP1	i
MOVLW	0x07	;Make RD<4:0> outputs
MOVWF	TRISD	;Make RD<7:5> inputs

FIGURE 5-6: PORTD<4:0> BLOCK DIAGRAM



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FIGURE 11-2: SSPCON: SYNC SERIAL PORT CONTROL REGISTER (ADDRESS 14h)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
WCOL bit7	SSPOV	SSPEN	СКР	SSPM3	SSPM2	SSPM1	SSPM0 bit0	R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'		
bit 7:	WCOL: We 1 = The SS (must be c 0 = No col	rite Collisic SPBUF reg leared in s lision	on Detect gister is wi software)	bit ritten while	it is still tr	ansmitting	the previou	is word		
bit 6:	SSPOV : R	eceive Ove	erflow Indi	icator bit						
	In SPI mode 1 = A new byte is received while the SSPBUF register is still holding the previous data. In case of overflow, the data in SSPSR is lost. Overflow can only occur in slave mode. The user must read the SSPBUF, even if only transmitting data, to avoid setting overflow. In master mode the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPBUF register. $0 = N_0$ overflow									
	$\frac{\ln I^2 C \mod}{1 = A \text{ byte}}$ in transmit 0 = No over	<u>le</u> is received mode. SS erflow	while the POV mus	SSPBUF I t be cleare	register is and in softwa	still holding are in eithe	g the previou er mode.	is byte. SSPOV is a "don't care"		
bit 5:	SSPEN: S	ynchronou	s Serial P	ort Enable	bit					
	$\frac{\text{In SPI mod}}{1 = \text{Enable}}$ $0 = \text{Disable}$	<u>de</u> es serial po es serial po	ort and col ort and co	nfigures So nfigures th	CK, SDO, nese pins a	and SDI a as I/O port	s serial port pins	pins		
	$\frac{\ln I \neq C \mod}{1 = \text{Enable}}$ $0 = \text{Disable}$ $\ln \text{ both mc}$	<u>te</u> es the seria es serial po odes, when	al port and ort and co enabled,	l configure nfigures th these pins	s the SDA nese pins a s must be	and SCL as I/O port properly co	pins as seri pins onfigured as	al port pins s input or output.		
bit 4:	CKP : Clock Polarity Select bit In SPI mode 1 = Idle state for clock is a high level 0 = Idle state for clock is a low level In I^2C mode SCK release control 1 = Enable clock 0 = Holds clock low (clock stretch) (Lised to ensure data setup time)									
bit 3-0:	: SSPM3:SSPM0 : Synchronous Serial Port Mode Select bits 0000 = SPI master mode, clock = Fosc/4 001 = SPI master mode, clock = Fosc/16 010 = SPI master mode, clock = Fosc/64 011 = SPI master mode, clock = TMR2 output/2 $0100 = SPI$ slave mode, clock = SCK pin. \overline{SS} pin control enabled. $0101 = SPI$ slave mode, clock = SCK pin. \overline{SS} pin control disabled. \overline{SS} can be used as I/O pin $0110 = I^2C$ slave mode, 7-bit address $0111 = I^2C$ slave mode, 10-bit address with start and stop bit interrupts enabled $1111 = I^2C$ slave mode, 10-bit address with start and stop bit interrupts enabled									

Figure 11-13 and Figure 11-14 show Master-transmitter and Master-receiver data transfer sequences.

When a master does not wish to relinquish the bus (by generating a STOP condition), a repeated START condition (Sr) must be generated. This condition is identical to the start condition (SDA goes high-to-low while SCL

is high), but occurs after a data transfer acknowledge pulse (not the bus-free state). This allows a master to send "commands" to the slave and then receive the requested information or to address a different slave device. This sequence is shown in Figure 11-15.

FIGURE 11-13: MASTER-TRANSMITTER SEQUENCE



FIGURE 11-14: MASTER-RECEIVER SEQUENCE

For 7-bit address:		For 10-bit address:
S Slave Address R/W A Da	ata A Data A P	S Slave Address R/W A1 Slave Address A2
'1' (read) —c (n by	lata transferred_ tes - acknowledge)	(write)
A master reads a slave imm	ediately after the first byte.	
From master to slave	$\begin{array}{l} \underline{A} = \operatorname{acknowledge} (SDA \ low) \\ \overline{A} = \operatorname{not} \ \operatorname{acknowledge} (SDA \ hightarrow \\ S = \operatorname{Start} \ Condition \\ P = \operatorname{Stop} \ Condition \end{array}$	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $

FIGURE 11-15: COMBINED FORMAT

	(read or write) (n bytes + acknowledge)			
S Slave Address R/W A	Data A/A Sr Slave Address R/W A Data A/A P			
(read)	Sr = repeated (write) Direction of transfer Start Condition may change at this point			
Transfer direction of data a	nd acknowledgment bits depends on R/\overline{W} bits.			
Combined format:	"			
SrSlave Address R/W A S First 7 bits	Slave Address A Data A Second byte Data A Second B Second B Se			
(write)	(read) — (read)			
Combined format - A master addresses a slave with a 10-bit address, then transmits data to this slave and reads data from this slave.				
From master to slave	A = acknowledge (SDA low) Ā = not acknowledge (SDA high) S = Start Condition P = Stop Condition			

11.2.4 MULTI-MASTER

The I^2C protocol allows a system to have more than one master. This is called multi-master. When two or more masters try to transfer data at the same time, arbitration and synchronization occur.

11.2.4.1 ARBITRATION

Arbitration takes place on the SDA line, while the SCL line is high. The master which transmits a high when the other master transmits a low loses arbitration (Figure 11-16), and turns off its data output stage. A master which lost arbitration can generate clock pulses until the end of the data byte where it lost arbitration. When the master devices are addressing the same device, arbitration continues into the data.

FIGURE 11-16: MULTI-MASTER ARBITRATION (TWO MASTERS)



Masters that also incorporate the slave function, and have lost arbitration must immediately switch over to slave-receiver mode. This is because the winning master-transmitter may be addressing it.

Arbitration is not allowed between:

- A repeated START condition
- A STOP condition and a data bit
- A repeated START condition and a STOP condition

Care needs to be taken to ensure that these conditions do not occur.

11.2.4.2 Clock Synchronization

Clock synchronization occurs after the devices have started arbitration. This is performed using a wired-AND connection to the SCL line. A high to low transition on the SCL line causes the concerned devices to start counting off their low period. Once a device clock has gone low, it will hold the SCL line low until its SCL high state is reached. The low to high transition of this clock may not change the state of the SCL line, if another device clock is still within its low period. The SCL line is held low by the device with the longest low period. Devices with shorter low periods enter a high wait-state, until the SCL line comes high. When the SCL line comes high, all devices start counting off their high periods. The first device to complete its high period will pull the SCL line low. The SCL line high time is determined by the device with the shortest high period, Figure 11-17.

FIGURE 11-17: CLOCK SYNCHRONIZATION



11.3 <u>SSP I²C Operation</u>

The SSP module in I²C mode fully implements all slave functions, except general call support, and provides interrupts on start and stop bits in hardware to facilitate firmware implementations of the master functions. The SSP module implements the standard mode specifications as well as 7-bit and 10-bit addressing. Two pins are used for data transfer. These are the RC3/SCK/SCL pin, which is the clock (SCL), and the RC4/SDI/SDA pin, which is the data (SDA). The user must configure these pins as inputs or outputs through the TRISC<4:3> bits. The SSP module functions are enabled by setting SSP Enable bit SSPEN (SSP-CON<5>).

FIGURE 11-18: SSP BLOCK DIAGRAM (I²C MODE)



The SSP module has five registers for $\mathsf{I}^2\mathsf{C}$ operation. These are the:

- SSP Control Register (SSPCON)
- SSP Status Register (SSPSTAT)
- Serial Receive/Transmit Buffer (SSPBUF)
- SSP Shift Register (SSPSR) Not directly accessible
- SSP Address Register (SSPADD)

The SSPCON register allows control of the I^2C operation. Four mode selection bits (SSPCON<3:0>) allow one of the following I^2C modes to be selected:

- I²C Slave mode (7-bit address)
- I²C Slave mode (10-bit address)
- I²C Slave mode (7-bit address), with start and stop bit interrupts enabled
- I²C Slave mode (10-bit address), with start and stop bit interrupts enabled
- I²C Firmware controlled Master Mode, slave is idle

Selection of any I²C mode, with the SSPEN bit set, forces the SCL and SDA pins to be open drain, provided these pins are programmed to inputs by setting the appropriate TRISC bits.

The SSPSTAT register gives the status of the data transfer. This information includes detection of a START or STOP bit, specifies if the received byte was data or address if the next byte is the completion of 10-bit address, and if this will be a read or write data transfer. The SSPSTAT register is read only.

The SSPBUF is the register to which transfer data is written to or read from. The SSPSR register shifts the data in or out of the device. In receive operations, the SSPBUF and SSPSR create a doubled buffered receiver. This allows reception of the next byte to begin before reading the last byte of received data. When the complete byte is received, it is transferred to the SSPBUF register and flag bit SSPIF is set. If another complete byte is received before the SSPBUF register is read, a receiver overflow has occurred and bit SSPOV (SSPCON<6>) is set and the byte in the SSPSR is lost.

The SSPADD register holds the slave address. In 10-bit mode, the user needs to write the high byte of the address (1111 0 A9 A8 0). Following the high byte address match, the low byte of the address needs to be loaded (A7:A0).

12.1 A/D Acquisition Requirements

For the A/D converter to meet its specified accuracy, the charge holding capacitor (CHOLD) must be allowed to fully charge to the input channel voltage level. The analog input model is shown in Figure 12-4. The source impedance (Rs) and the internal sampling switch (Rss) impedance directly affect the time required to charge the capacitor CHOLD. The sampling switch (Rss) impedance varies over the device voltage (VDD), (Figure 12-4). The source impedance affects the offset voltage at the analog input (due to pin leakage current). **The maximum recommended impedance for analog sources is 10 k** Ω . After the analog input channel is selected (changed) this acquisition must be done before the conversion can be started.

To calculate the minimum acquisition time, Equation 12-1 may be used. This equation calculates the acquisition time to within 1/2 LSb error (512 steps for the A/D). The 1/2 LSb error is the maximum error allowed for the A/D to meet its specified accuracy.

EQUATION 12-1: A/D MINIMUM CHARGING TIME

 $VHOLD = (VREF - (VREF/512)) \bullet (1 - e^{(-Tc/CHOLD(Ric + Rss + Rs))})$

Given: VHOLD = (VREF/512), for 1/2 LSb resolution

The above equation reduces to:

 $Tc = -(51.2 \text{ pF})(1 \text{ k}\Omega - \text{Rss} + \text{Rs}) \ln(1/511)$

Example 12-1 shows the calculation of the minimum required acquisition time (TACQ). This calculation is based on the following system assumptions.

CHOLD = 51.2 pF

 $Rs = 10 \ k\Omega$

1/2 LSb error

 $VDD = 5V \rightarrow Rss = 7 \ k\Omega$

Temp (system max.) = 50°C

VHOLD = 0 @ t = 0



- Note 1: The reference voltage (VREF) has no effect on the equation, since it cancels itself out.
- **Note 2:** The charge holding capacitor (CHOLD) is not discharged after each conversion.
- **Note 3:** The maximum recommended impedance for analog sources is 10 k Ω . This is required to meet the pin leakage specification.
- Note 4: After a conversion has completed, a 2.0 TAD delay must complete before acquisition can begin again. During this time the holding capacitor is not connected to the selected A/D input channel.

EXAMPLE 12-1: CALCULATING THE MINIMUM REQUIRED SAMPLE TIME

TACQ = Amplifier Settling Time +

- Holding Capacitor Charging Time + Temperature Coefficient
- TACQ = $5 \,\mu s + Tc + [(Temp 25^{\circ}C)(0.05 \,\mu s/^{\circ}C)]$
- TC = -CHOLD (RIC + RSS + RS) ln(1/511) -51.2 pF (1 k Ω + 7 k Ω + 10 k Ω) ln(0.0020) -51.2 pF (18 k Ω) ln(0.0020) -0.921 μ s (-6.2364) 5.747 μ s TACO = 5 μ s + 5 747 μ s + 1/50°C - 25°C)(0.05 μ s/°C
- TACQ = 5 μs + 5.747 μs + [(50°C 25°C)(0.05 μs/°C)] 10.747 μs + 1.25 μs 11.997 μs







FIGURE 13-7: WAVEFORMS IN 1/4 MUX, 1/3 BIAS



14.4 <u>Power-on Reset (POR), Power-up</u> <u>Timer (PWRT) and Oscillator Start-up</u> <u>Timer (OST)</u>

14.4.1 POWER-ON RESET (POR)

A Power-on Reset pulse is generated on-chip when VDD rise is detected (in the range of 1.5V - 2.1V). To take advantage of the POR, just tie the \overline{MCLR} pin directly (or through a resistor) to VDD. This will eliminate external RC components usually needed to create a Power-on Reset. A maximum rise time for VDD is specified. See Electrical Specifications for details.

When the device starts normal operation (exits the reset condition), device operating parameters (voltage, frequency, temperature, ...) must be met to ensure operation. If these conditions are not met, the device must be held in reset until the operating conditions are met.

For additional information, refer to Application Note AN607, "*Power-up Trouble Shooting*."

14.4.2 POWER-UP TIMER (PWRT)

The Power-up Timer provides a fixed 72 ms nominal time-out on power-up only, from the POR. The Power-up Timer operates on an internal RC oscillator. The chip is kept in reset as long as the PWRT is active. The PWRT's time delay allows VDD to rise to an accept-able level. A configuration bit is provided to enable/disable the PWRT.

The power-up time delay will vary from chip to chip due to VDD, temperature, and process variation. See DC parameters for details.

14.4.3 OSCILLATOR START-UP TIMER (OST)

The Oscillator Start-up Timer (OST) provides 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over. This ensures that the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for XT, LP and HS modes and only on Power-on Reset or wake-up from SLEEP.

14.4.4 TIME-OUT SEQUENCE

On power-up the time-out sequence is as follows: First PWRT time-out is invoked after the POR time delay has expired. Then OST is activated. The total time-out will vary based on oscillator configuration and the status of the PWRT. For example, in RC mode with the PWRT disabled, there will be no time-out at all. Figure 14-8, Figure 14-9, and Figure 14-10 depict time-out sequences on power-up.

Since the time-outs occur from the POR pulse, if $\overline{\text{MCLR}}$ is kept low long enough, the time-outs will expire. Then bringing $\overline{\text{MCLR}}$ high will begin execution immediately (Figure 14-9). This is useful for testing purposes or to synchronize more than one PIC16CXXX device operating in parallel.

Table 14-5 shows the reset conditions for some special function registers, while Table 14-6 shows the reset conditions for all the registers.

14.4.5 POWER CONTROL/STATUS REGISTER (PCON)

Bit1 is Power-on Reset Status bit POR. It is cleared on a Power-on Reset and unaffected otherwise. The user must set this bit following a Power-on Reset.

Oscillator Configuration	Powe	Wake-up from SLEEP	
	PWRTE = 1	PWRTE = 0	
XT, HS, LP	1024Tosc	72 ms + 1024Tosc	1024 Tosc
RC.		72 ms	

TABLE 14-3: TIME-OUT IN VARIOUS SITUATIONS





FIGURE 14-9: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 2



FIGURE 14-10:TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD)



PIC16C9XX

BTFSS	Bit Test f, Skip if Set				CALL	Call Sub	oroutine		
Syntax:	[<i>label</i>] BT	FSS f,b			Syntax:	[<i>label</i>] CALL k			
Operands:	$0 \le f \le 12$	7			Operands:	$0 \le k \le 2047$			
Operation:	0 ≤ b < 7 skip if (f<	b>) = 1			Operation:	$(PC)+1 \rightarrow TOS, k \rightarrow PC<10:0>, (PC) 4711-422 \rightarrow PC-42:44$.11.
Status Affected:	None		1		•	(PCLAIF	1<4.3>) -	→ PG<12	.11>
Encoding:	01	11bb	bfff	ffff	Status Affected:	None			
Description:	If bit 'b' in register 'f' is '0' then the next instruction is executed. If bit 'b' is '1', then the next instruction is discarded and a NOP is executed instead, making this a 2TCY instruction.				Encoding: Description:	Call Subroutine. First, return address (PC+1) is pushed onto the stack. The eleven bit immediate address is loader into PC bits <10:0>. The upper bits of			ddress ck. The s loaded bits of
Words:	1					the PC are	e loaded fr /cle instrue	om PCLA1	TH. CALL
Cycles:	1(2)				Words:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4	Cycles:	2			
	Decode	Read register 'f'	Process data	No- Operation	Q Cycle Activity:	Q1	Q2	Q3	Q4
If Skip:	(2nd Cyc	le)			1st Cycle	Decode	Read literal 'k',	Process data	Write to PC
	Q1	Q2	Q3	Q4			Push PC to Stack		
	No- Operation	No- Operation	No- Operation	No- Operation	2nd Cycle	No- Operation	No- Operation	No- Operation	No- Operation
Example	HERE FALSE TRUE	BTFSC GOTO •	FLAG,1 PROCESS_	_CODE	Example	HERE Before Ir	CALL	THERE	
		•				After Ins	PC = A truction	ddress HE	RE
	Before In After Inst	struction PC = a ruction if FLAG<1> PC = a if FLAG<1> PC = a	address H = 0, address FT > = 1, address TF	IERE			PC = A TOS = A	ddress TH ddress HE	IERE RE+1

DECFSZ	Decreme	ent f, Skip	o if O		GOTO	Uncondi	tional Br	anch		
Syntax:	[label]	DECFSZ	f,d		Syntax:	[label]	[<i>label</i>] GOTO k			
Operands:	$0 \le f \le 12$	27			Operands:	$0 \le k \le 2047$				
	d ∈ [0,1]				Operation:	$k \rightarrow PC < 10:0 >$				
Operation:	(f) - 1 \rightarrow	(destinatio	on);			$PCLATH{<}4{:}3{>} \rightarrow PC{<}12{:}11{>}$				
	skip ii res	suit = 0			Status Affected:	None	None			
Status Affected:	None				Encoding:	10	1kkk	kkkk	kkkk	
Encoding:	00	1011	dfff	ffff	Description:	GOTO is ar	n unconditi	onal branc	h. The	
Description:	The contents of register 'f' are decre- mented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.				·	eleven bit immediate value is loaded into PC bits <10:0>. The upper bits of PC are loaded from PCLATH<4:3>. GOTO is a two cycle instruction.				
	executed. I	f the result	is 0, then a	NOP is	Words:	1				
	executed instead making it a 2Tcy instruc- tion.				Cycles:	2				
Words:	1				Q Cycle Activity:	Q1	Q2	Q3	Q4	
Cycles:	1(2)				1st Cycle	Decode	Read literal 'k'	Process data	Write to PC	
Q Cycle Activity:	Q1	Q2	Q3	Q4	2nd Cycle	No-	No-	No-	No-	
	Decode	Read register 'f'	Process data	Write to destination		Operation	Operation	Operation	Operation	
If Skip:	(2nd Cyc	:le)			Example	GOTO T	HERE			
	Q1	Q2	Q3	Q4		After Inst	ruction			
	No- Operation	No- Operation	No- Operation	No- Operation			PC = .	Address	THERE	
Example	HERE	DECFS GOTO UE • •	Z CNT LOOI	, 1						
	Before In PC After Inst CNT if CNT PC if CNT PC	struction = addr ruction = CNT = 0, = addr \neq 0, = addr	ess here - 1 ess Cont ess here	INUE +1						

NOP	No Operation					
Syntax:	[label]	NOP				
Operands:	None					
Operation:	No opera	ation				
Status Affected:	None					
Encoding:	00	0000	0xx0	0000		
Description:	No operat	ion.				
Words:	1					
Cycles:	1					
Q Cycle Activity:	Q1	Q2	Q3	Q4		
	Decode	No- Operation	No- Operation	No- Operation		
Example	NOP					

RETFIE	Return from Interrupt					
Syntax:	[label]	RETFIE				
Operands:	None					
Operation:	$\begin{array}{l} \text{TOS} \rightarrow \text{PC}, \\ 1 \rightarrow \text{GIE} \end{array}$					
Status Affected:	None					
Encoding:	00	0000	0000	1001		
Description:	Return from Interrupt. Stack is POPer and Top of Stack (TOS) is loaded in th PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a two cycle instruction.					
Words:	1					
Cycles:	2					
Q Cycle Activity:	Q1	Q2	Q3	Q4		
1st Cycle	Decode	No- Operation	Set the GIE bit	Pop from the Stack		
2nd Cycle	No- Operation	No- Operation	No- Operation	No- Operation		

Example

RETFIE

After Interrupt

PC	=	TOS
GIE	=	1

OPTION	Load Option Register					
Syntax:	[label]	OPTION	٧			
Operands:	None					
Operation:	$(W) \to OPTION$					
Status Affected:	None					
Encoding:	00 0000 0110 00					
Description:	I ne contents of the W register are loaded in the OPTION register. This instruction is supported for code com- patibility with PIC16C5X products. Since OPTION is a readable/writable register, the user can directly address it.					
Words:	1					
Cycles:	1					
Example						
	To maintain upward compatibility with future PIC16CXX products, do not use this instruction.					

FIGURE 17-12:I²C BUS START/STOP BITS TIMING



TABLE 17-10:I²C BUS START/STOP BITS REQUIREMENTS

Parameter	Sym	Characteristic		Min	Тур	Max	Units	Conditions
No.								
90*	TSU:STA	START condition Setup time	100 kHz mode	4700	—	_	ns	Only relevant for repeated START condition
91*	THD:STA	START condition Hold time	100 kHz mode	4000	—	—	ns	After this period the first clock pulse is generated
92*	Tsu:sto	STOP condition Setup time	100 kHz mode	4700	—	_	ns	
93*	THD:STO	STOP condition Hold time	100 kHz mode	4000	_	—	ns	

Characterized but not tested.

FIGURE 17-14:A/D CONVERSION TIMING



TABLE 17-13:A/D CONVERSION REQUIREMENTS

Param No.	Sym	Characteristic		Min	Тур†	Мах	Units	Conditions
130	TAD	A/D clock period	PIC16 C 924	1.6			μs	Tosc based, VREF ≥ 3.0V
			PIC16 LC 924	2.0	—	—	μs	Tosc based, VREF full range
			PIC16 C 924	2.0	4.0	6.0	μs	A/D RC Mode
			PIC16 LC 924	3.0	6.0	9.0	μs	A/D RC Mode
131	TCNV	Conversion time (not including S/H time) (Note 1)			9.5		TAD	
132	TACQ	Acquisition time		Note 2	20	_	μs	
				5*			μs	The minimum time is the amplifier settling time. This may be used if the "new" input voltage has not changed by more than 1 LSb (i.e., 20.0 mV @ 5.12V) from the last sampled voltage (as stated on CHOLD).
134	TGO	Q4 to A/D clock start			Tosc/2 §		_	If the A/D clock source is selected as RC, a time of TCY is added before the A/D clock starts. This allows the SLEEP instruction to be executed.
135	Tswc	Switching from convert	ightarrow sample time	1.5 §	—	—	TAD	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

Note 1: ADRES register may be read on the following TCY cycle.

2: See Section 12.1 for min conditions.

FIGURE 18-9: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD



FIGURE 18-10:TYPICAL RC OSCILLATOR FREQUENCY vs. VDD



FIGURE 18-11:TYPICAL RC OSCILLATOR FREQUENCY vs. VDD



FIGURE 18-12:TYPICAL IPD vs. TIMER1 ENABLED (32 kHz, RC0/RC1 = 33 pF/33 pF, RC MODE)



FIGURE 18-13:MAXIMUM IPD vs. TIMER1 ENABLED (32 kHz, RC0/RC1 = 33 pF/33 pF, 85°C TO -40°C, RC MODE)



Data based on process characterization samples. See first page of this section for details.



FIGURE 18-23: TYPICAL XTAL STARTUP TIME

FIGURE 18-24:TYPICAL XTAL STARTUP TIME vs. VDD (HS MODE, 25°C)



FIGURE 18-25:TYPICAL XTAL STARTUP TIME vs. VDD (XT MODE, 25°C)





FIGURE 18-27:MAXIMUM IDD vs. VDD (LP MODE -40°C TO +85°C)





PIC16C9XX

NOTES:

PIC16C9XX

APPENDIX C: WHAT'S NEW

Figure 13-13 (Resistor Ladder and Charge Pump) in LCD Section.

Parameter D150 - Open Drain High Voltage.

DC and AC Characterization Graphs and Tables.

APPENDIX D: WHAT'S CHANGED

Various descriptions for clarity.

Example code for Changing prescaler assignment between Timer0 and the WDT.

The A/D section has many changes that provide greater clarification of A/D operation.

The Instruction Set has Q-cycle activity listings for every instruction.

The following Electrical Characteristic Parameter values have changed to:

age Devices, C) μΑ μΑ						
age Devices) μΑ μΑ						
age Devices) μΑ μΑ						
age Devices, LC) V						
age Devices, LC) μΑ μΑ						
age Devices, LC) μΑ μΑ						
age Devices, LC) μΑ μΑ						
V (entire range) V (4.5V \leq Vdd \leq 5.5V)						
Deleted D210 and D211, D251, D253, D260, D271						
kHz kHz kHz						
D223, D224 - units to ns.						
DJ voltage limits.						
Changed parameters:						
35 ns Typical						
35 ns Typical						
Tosc + 200 ns Min						

- 18 TosH2ioL 200 ns Min (LC devices)
- 30 TmcL 2 μs Min
- 34 Tioz 2.1 µs Max

Timer0 and Timer1 External Clock Timings - Various.

- 53 TccR.
- 54 TccF
- 73 TdiV2scH 50 ns Min
- 74 TscH2diL 50 ns Min

Combined A/D specification tables for Standard and Extended Voltage devices.



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